

Automotive MOSFET

OptiMOS™-5 Power-Transistor







Features

- OptiMOS[™] power MOSFET for automotive applications
- N-channel Enhancement mode Normal Level
- Extended qualification beyond AEC-Q101
- Enhanced electrical testing
- Robust design
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- Green product (RoHS compliant)
- 100% Avalanche tested

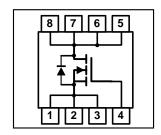
Potential applications

General automotive applications.

Product validation

Qualified for automotive applications. Product validation according to AEC-Q101.





Product Summary

V_{DS}	60	٧
R _{DS(on)}	3.23	mΩ
I _D (chip limited)	120	Α

Туре	Package	Marking
IAUC120N06S5N032	PG-TDSON-8-34	5N06N032

IAUC120N06S5N032



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Maximum ratings

at Tj=25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I _D	V _{GS} =10 V, Chip limitation ^{1,2)}	120	А
		V _{GS} =10V, DC current ³⁾	120	
		T_a =85 °C, V_{GS} =10 V, R_{thJA} on 2s2p ^{2,4)}	24	
Pulsed drain current ²⁾	/ _{D,pulse}	T _C =25 °C, t _p = 100 μs	389]
Avalanche energy, single pulse ²⁾	E _{AS}	/ _D =60 A	82	mJ
Avalanche current, single pulse	I _{AS}	-	100	А
Gate source voltage	V _{GS}	-	±20	V
Power dissipation	P tot	Т _С =25 °С	94	W
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-	-55 +175	°C
IEC climatic category; DIN IEC 68-1	-	-	55/175/56	

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Thermal characteristics²⁾

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Thermal resistance, junction - case	R thJC	-	-	-	1.60	K/W
Thermal resistance, junction - ambient ⁴⁾	R _{thJA}	-	-	24.2	-	

Electrical characteristics

at Tj=25 °C, unless otherwise specified

Parameter	Symbol	Symbol Conditions	Values			Unit
			min.	typ.	max.	
Static characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V_{GS} =0 V, I_{D} =1 mA	60	-	-	V
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 44 \mu A$	2.2	2.8	3.4	
Zero gate voltage drain current	I _{DSS}	$V_{\rm DS}$ =60 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C	_	-	1	μΑ
		V_{DS} =60 V, V_{GS} =0 V, T_{j} =100 °C ²⁾	-	-	100	
Gate-source leakage current	I _{GSS}	V _{GS} =20 V, V _{DS} =0 V	-	-	100	nA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =7 V, I _D =30 A	-	3.29	3.99	mΩ
		V _{GS} =10 V, I _D =60 A	-	2.66	3.23	
Gate resistance ²⁾	R _G	-	-	1.2	_	Ω

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Parameter	Symbol Conditions		Values			Unit
			min.	typ.	max.	
Dynamic characteristics ²⁾						
Input capacitance	C iss		-	2651	3446	pF
Output capacitance	C oss	V_{GS} =0 V, V_{DS} =30 V, f =1 MHz	_	554	720	
Reverse transfer capacitance	C _{rss}		-	24	36	
Turn-on delay time	t d(on)		_	7	_	ns
Rise time	t _r	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =60 A,	_	5	_	
Turn-off delay time	t _{d(off)}	$R_{\rm G}$ =3.5 Ω	_	10	_	
Fall time	t _f		_	7	_	
Gate to drain charge Cate charge total	Q gs Q gd	V_{DD} =30 V, I_{D} =60 A, V_{GS} =0 to 10 V	-	7	14 11	nC
Gate charge total	Q _g	V _{GS} =0 to 10 V	_	36	47	_
Gate plateau voltage	$V_{\rm plateau}$		-	4.9	_	٧
Reverse Diode						
Diode continous forward current ²⁾	I _s	T _C =25 °C	-	_	120	Α
Diode pulse current ²⁾	I _{S,pulse}	$T_{\rm C}$ =25 °C, $t_{\rm p}$ = 100 μ s	ı	-	384	
Diode forward voltage	V _{SD}	V_{GS} =0 V, I_{F} =60 A, T_{j} =25 °C	-	0.8	1.1	V
Reverse recovery time ²⁾	t rr	V _R =30 V, I _F =50A,	-	40	_	ns
Reverse recovery charge ²⁾	Q _{rr}	d <i>i</i> _F /d <i>t</i> =100 A/μs	_	32	-	nC

¹⁾ Practically the current is limited by the overall system design including the customer-specific PCB.

 $^{^{2)}\,\}mbox{The parameter}$ is not subject to production testing – specified by design.

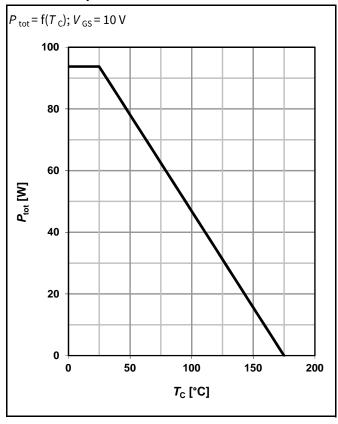
³⁾ Current is limited by package.

⁴⁾ Device on 2s2p FR4 PCB defined in accordance with JEDEC standards (JESD51-5, -7). PCB is vertical in still air.

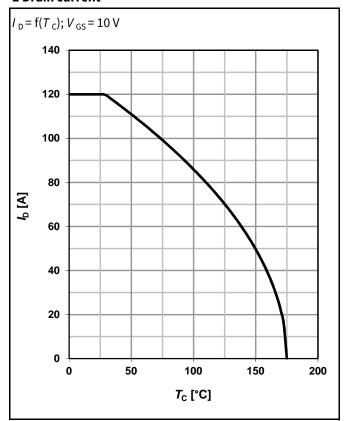


Electrical characteristics diagrams

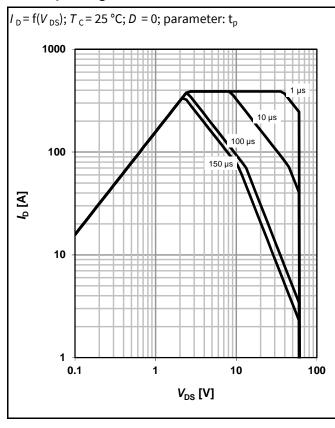
1 Power dissipation



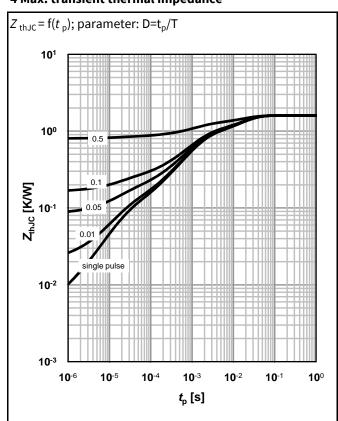
2 Drain current



3 Safe operating area

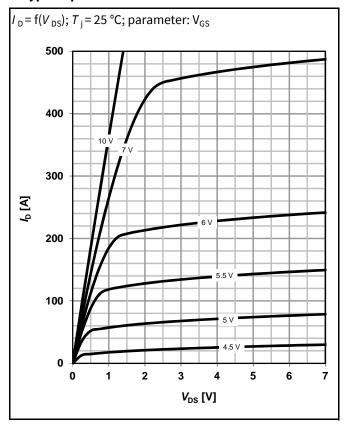


4 Max. transient thermal impedance

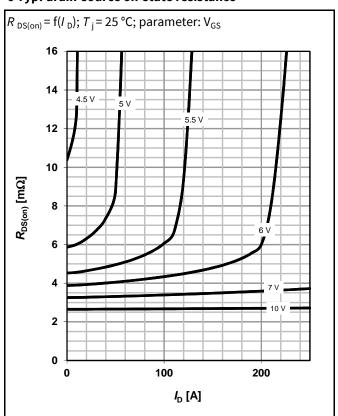




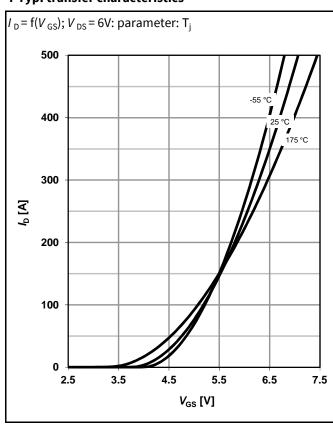
5 Typ. output characteristics



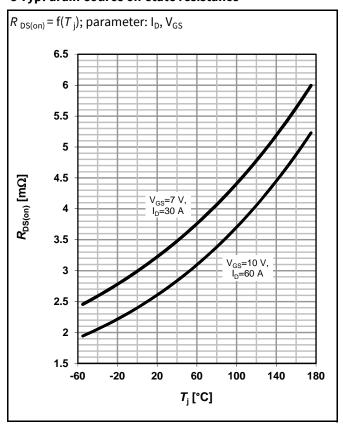
6 Typ. drain-source on-state resistance



7 Typ. transfer characteristics

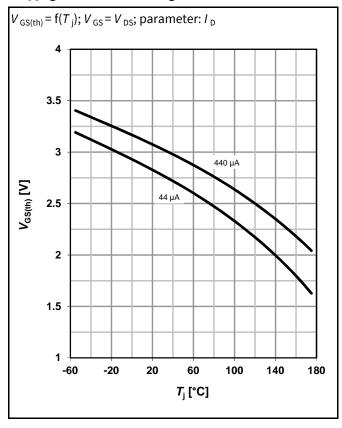


8 Typ. drain-source on-state resistance

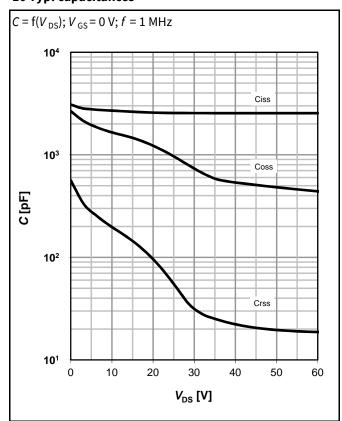


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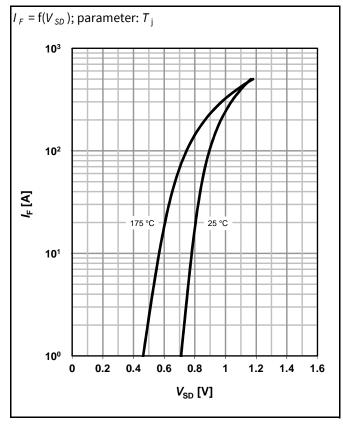
9 Typ. gate threshold voltage



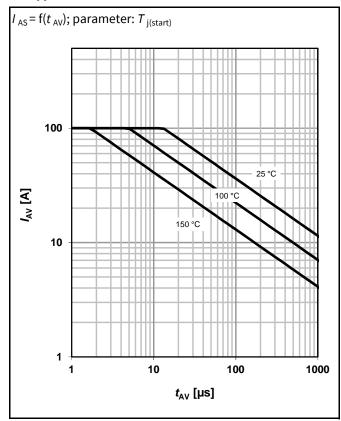
10 Typ. capacitances



11 Typical forward diode characteristics

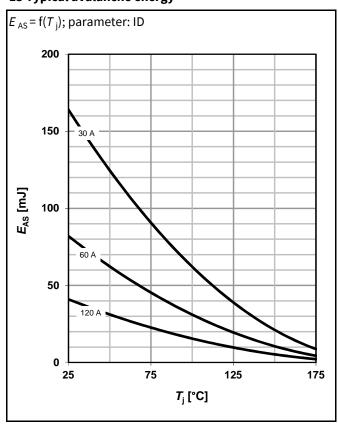


12 Typ. avalanche characteristics

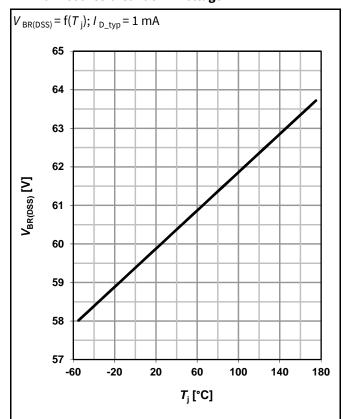




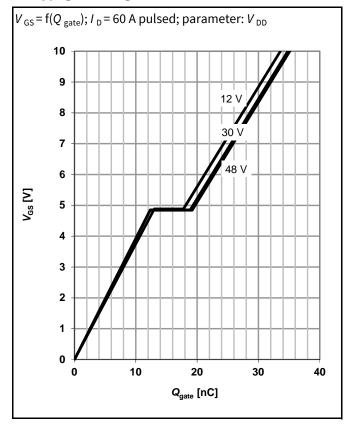
13 Typical avalanche energy



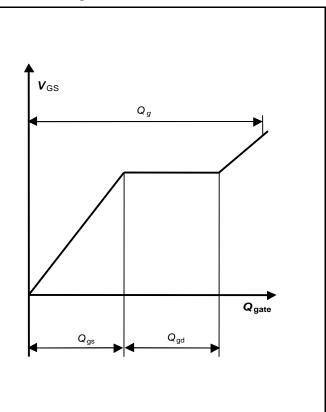
14 Drain-source breakdown voltage



15 Typ. gate charge



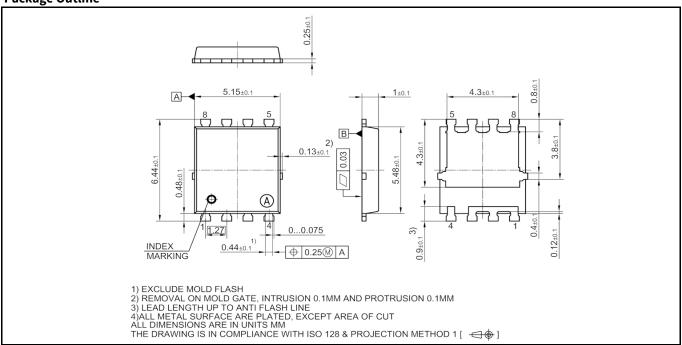
16 Gate charge waveforms



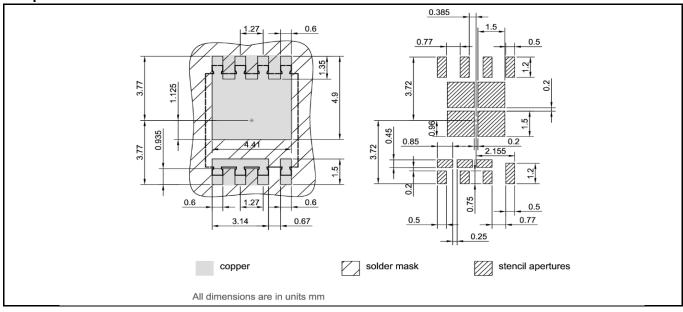
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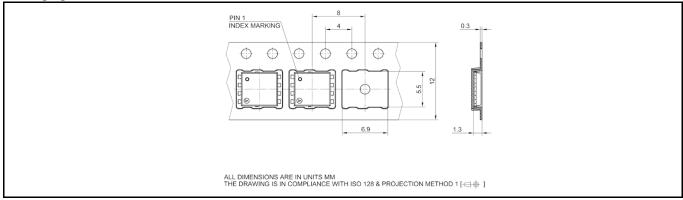
Package Outline



Footprint



Packaging



IAUC120N06S5N032



Revision History

Revision	Date	Changes
Revision 1.0	21.06.2022	Final Data Sheet

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